

IRF624STRL Datasheet

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DiGi Electronics Part Number	IRF624STRL-DG
Manufacturer	Vishay Siliconix
Manufacturer Product Number	IRF624STRL
Description	MOSFET N-CH 250V 4.4A D2PAK
Detailed Description	N-Channel 250 V 4.4A (Tc) 3.1W (Ta), 50W (Tc) Surf ace Mount TO-263 (D2PAK)

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
IRF624STRL	Vishay Siliconix
Series:	Product Status:
-	Active
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
250 V	4.4A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
10V	1.10hm @ 2.6A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
4V @ 250µA	14 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	260 pF @ 25 V
FET Feature:	Power Dissipation (Max):
-	3.1W (Ta), 50W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
ТО-263 (D2PAK)	TO-263-3, D2PAK (2 Leads + Tab), TO-263AB
Base Product Number:	
IRF624	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
RoHS non-compliant	1 (Unlimited)
ECCN:	HTSUS:
EAR99	8541.29.0095



D²PAK (TO-263)

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{qs} (nC)

Q_{gd} (nC)

Q_q max. (nC)

Configuration

IRF624S, SiHF624S

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S

N-Channel MOSFET

250

14

2.7

7.8

Single

1.1

V_{GS} = 10 V



- Surface-mount
- Available in tape and reel
- Dynamic dv/dt rating
- · Repetitive avalanche rated
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D²PAK (TO-263) is a surface-mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface-mount package. The D²PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface-mount application.

ORDERING INFORMATION	
Package	D ² PAK (TO-263)
Lead (Pb)-free and halogen-free	SiHF624S-GE3
Lead (Pb)-free	IRF624SPbF

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, un	less otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	250	v
Gate-source voltage			V _{GS}	± 20	v
Continuous drain current V_{GS} at 10 V $\frac{T_C = 25 \degree C}{T_C = 100 \degree C}$				4.4	
	I _D	2.8	А		
Pulsed drain current ^a		I _{DM}	14		
Linear derating factor		0.40	W/°C		
Linear derating factor (PCB mount) ^e		0.025	VV/ C		
Single pulse avalanche energy ^b		E _{AS}	100	mJ	
Repetitive avalanche current ^a		I _{AR}	4.4	A	
Repetitive avalanche energy ^a			E _{AR}	5.0	mJ
Maximum power dissipation		50	w		
Maximum power dissipation (PCB mount) e	P _D	3.1	vv		
Peak diode recovery dv/dt ^c	dv/dt	4.8	V/ns		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) ^d	_	300			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 8.3 mH, $R_g = 25 \Omega$, $I_{AS} = 4.4 \text{ A}$ (see fig. 12)

c.
$$I_{SD} \le 4.4$$
 A, di/dt ≤ 90 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C

d. 1.6 mm from case

e. When mounted on 1" square PCB (FR-4 or G-10 material)

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THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Maximum junction-to-ambient (PCB mount) ^a	R _{thJA}	-	-	40			
Maximum junction-to-ambient	R _{thJA}	-	-	62	°C/W		
Maximum junction-to-case (drain)	R _{thJC}	-	-	2.5			

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material)

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		-					
Drain-source breakdown voltage	V _{DS}	V _{GS}	= 0, I _D = 250 μA	250	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.36	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-source leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
Zara gata valtaga drain overant	1	V _{DS} =	= 250 V, V _{GS} = 0 V	-	-	25	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 200V	, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 2.6 A ^b	-	-	1.1	Ω
Forward transconductance	9 _{fs}	V _{DS} =	50 V, I _D = 2.6 A ^b	1.5	-	-	S
Dynamic				•		•	
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	260	-	
Output capacitance	C _{oss}		$V_{DS} = 25 V$,	-	77	-	pF
Reverse transfer capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	-	15	-	
Total gate charge	Qg			-	-	14	1
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 4.4 \text{ A}, V_{DS} = 200 \text{ V}$ see fig. 6 and 13 b		-	-	2.7	nC
Gate-drain charge	Q _{gd}		see lig. o and to	-	-	7.8	1
Turn-on delay time	t _{d(on)}	$V_{DD} = 125 \text{ V}, \text{ I}_D = 4.4 \text{ A}$ $R_g = 18 \Omega, R_D = 28 \Omega$ see fig. 10 ^b		-	7.0	-	- ns
Rise time	t _r			-	13	-	
Turn-off delay time	t _{d(off)}			-	20	-	
Fall time	t _f			-	12	-	
Gate input resistance	Rg	f = 1	MHz, open drain	0.7	-	5.4	Ω
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from		-	4.5	-	- nH
Internal source inductance	L _S		die contact		7.5	-	
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	4.4	
Pulsed diode forward current ^a	I _{SM}			-	-	14	A
Body diode voltage	V _{SD}	T _J = 25 °C	, $I_{\rm S}$ = 4.4 A, $V_{\rm GS}$ = 0 V ^b	-	-	1.8	V
Body diode reverse recovery time	t _{rr}	T.1 =	25 °C, I _F = 4.4 A,	-	200	400	ns
Body diode reverse recovery charge	Q _{rr}	di/	dt = 100 A/µs ^b	-	0.93	1.9	μC
Forward turn-on time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	by L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

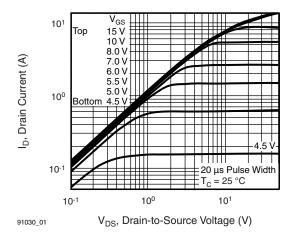


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

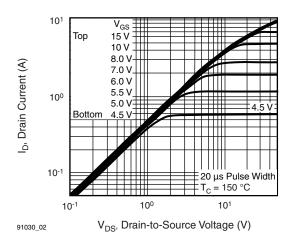


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

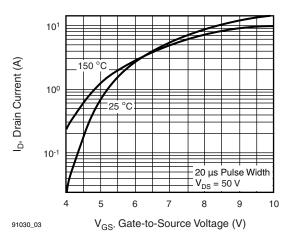


Fig. 3 - Typical Transfer Characteristics

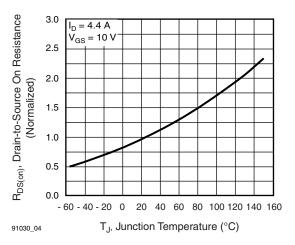


Fig. 4 - Normalized On-Resistance vs. Temperature

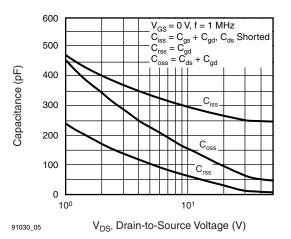


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

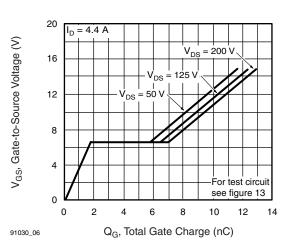


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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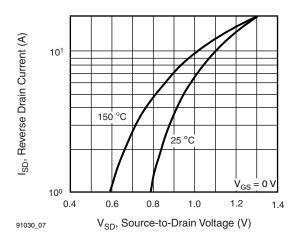


Fig. 7 - Typical Source-Drain Diode Forward Voltage

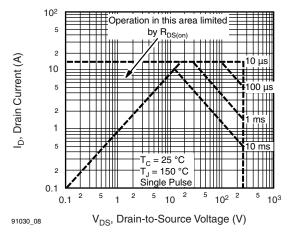
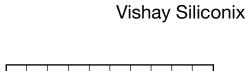


Fig. 8 - Maximum Safe Operating Area



IRF624S, SiHF624S

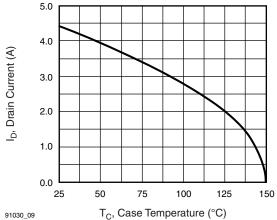


Fig. 9 - Maximum Drain Current vs. Case Temperature

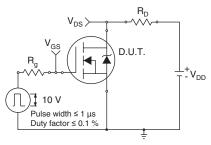


Fig. 10a - Switching Time Test Circuit

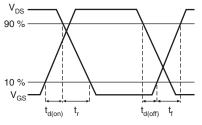
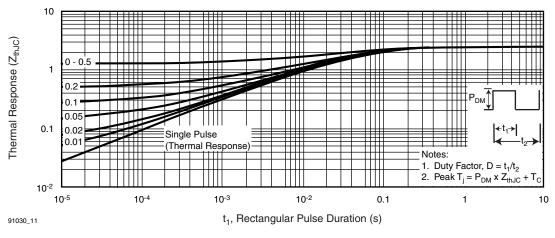


Fig. 10b - Switching Time Waveforms





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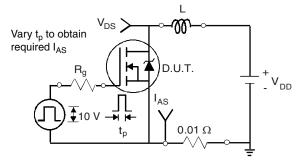


Fig. 12a - Unclamped Inductive Test Circuit

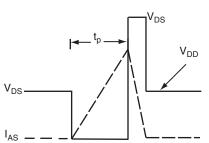


Fig. 12b - Unclamped Inductive Waveforms

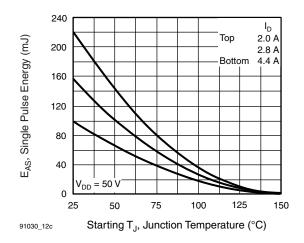


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

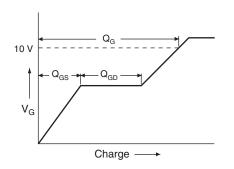


Fig. 13a - Basic Gate Charge Waveform

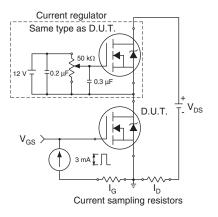


Fig. 13b - Gate Charge Test Circuit

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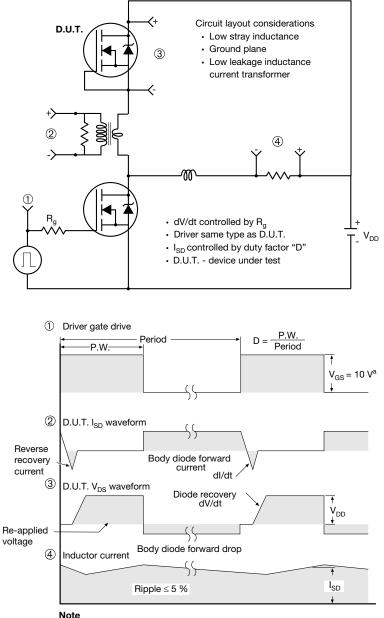


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a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

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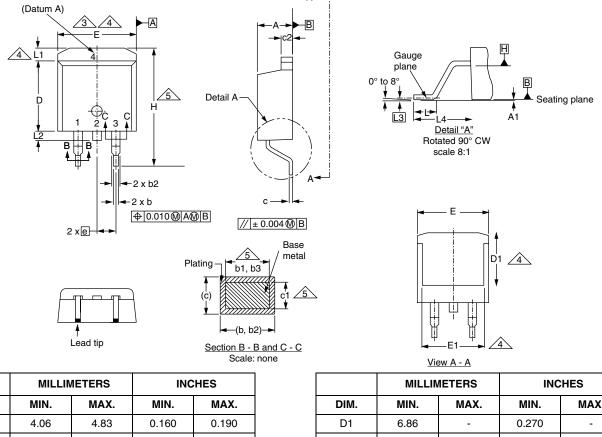
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Package Information

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TO-263AB (HIGH VOLTAGE)



А

DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.
А	4.06	4.83	0.160	0.190	D1	6.86	-	0.270
A1	0.00	0.25	0.000	0.010	E	9.65	10.67	0.380
b	0.51	0.99	0.020	0.039	E1	6.22	-	0.245
b1	0.51	0.89	0.020	0.035	е	2.54	BSC	0.100
b2	1.14	1.78	0.045	0.070	Н	14.61	15.88	0.575
b3	1.14	1.73	0.045	0.068	L	1.78	2.79	0.070
С	0.38	0.74	0.015	0.029	L1	-	1.65	-
c1	0.38	0.58	0.015	0.023	L2	-	1.78	-
c2	1.14	1.65	0.045	0.065	L3	0.25	BSC	0.010
D	8.38	9.65	0.330	0.380	L4	4.78	5.28	0.188

Notes

2. Dimensions are shown in millimeters (inches).

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.

^{1.} Dimensioning and tolerancing per ASME Y14.5M-1994.

^{3.} Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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